

500 mA PNP general-purpose transistors Rev. 05 — 1 February 2010

Product data sheet

1. **Product profile**

1.1 General description

PNP transistors in a SOT323 (SC-70) very small Surface-Mounted Device (SMD) plastic package.

Table 1. **Product overview**

Type number	Package		NPN complement
	NXP	JEITA	
PMSTA55	SOT323	SC-70	PMSTA05
PMSTA56	_		PMSTA06

1.2 Features

- High current (max. 500 mA)
- Collector-emitter voltage:
 - ◆ 60 V (PMSTA55)
 - ◆ 80 V (PMSTA56)

1.3 Applications

Intended for telephony and professional communication equipment.

Pinning information 2.

Pin	Description	Simplified outline	Graphic symbol
1	base		
2	emitter		3
3	collector	1 2	
			006aab25



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3. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
PMSTA55	SC-70	plastic surface-mounted package; 3 leads	SOT323			
PMSTA56						

4. Marking

Type numberMarking codePMSTA55*2H		Table 4. Marking codes
PMSTA55 *2H	Marking code ^[1]	Type number
	*2H	PMSTA55
PMSTA56 *2G	*2G	PMSTA56

- [1] * = -: made in Hong Kong
 - * = p: made in Hong Kong
 - * = t: made in Malaysia
 - * = W: made in China

5. Limiting values

Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

			-		
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter			
	PMSTA55		-	-60	V
	PMSTA56		-	-80	V
V _{CEO}	collector-emitter voltage	open base			
	PMSTA55		-	-60	V
	PMSTA56		-	-80	V
V _{EBO}	emitter-base voltage	open collector	-	-4	V
I _C	collector current		-	-500	mA
I _{CM}	peak collector current		-	-500	mA
I _{BM}	peak base current		-	-500	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> -	200	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

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6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u> _	-	625	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

7. Characteristics

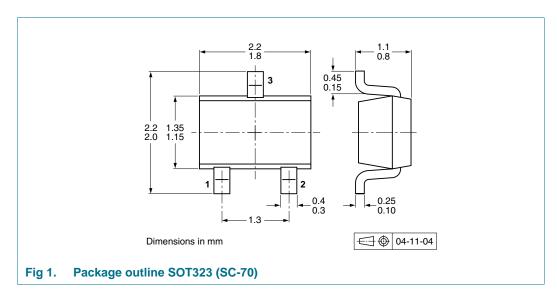
Table 7. $T_{amb} = 25$	Characteristics °C unless otherwise sp	ecified.					
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off current						
	PMSTA55	$V_{CB} = -60 \text{ V}; \text{ I}_{E} = 0 \text{ A}$		-	-	-100	nA
	PMSTA56	$V_{CB} = -80 \text{ V}; \text{ I}_{E} = 0 \text{ A}$		-	-	-100	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = -4 \text{ V}; \text{ I}_{C} = 0 \text{ A}$		-	-	-500	nA
h _{FE} DC current gair	DC current gain	$V_{CE} = -1 V;$ $I_{C} = -10 mA$		100	-	-	
		$V_{CE} = -1 V;$ $I_{C} = -100 \text{ mA}$	<u>[1]</u>	100	-	-	
V _{CEsat}	collector-emitter saturation voltage	$I_{\rm C} = -100 \text{ mA};$ $I_{\rm B} = -10 \text{ mA}$		-	-	-250	mV
V_{BE}	base-emitter voltage	$I_{C} = -100 \text{ mA};$ $V_{CE} = -1 \text{ V}$		-	-	-1.2	mV
f _T	transition frequency	$V_{CE} = -1 V;$ $I_{C} = -100 \text{ mA};$ f = 100 MHz		50	-	-	MHz

 $\label{eq:point} \begin{tabular}{ll} \mbox{Pulse test: } t_p \leq 300 \ \mu \mbox{s; } \delta \leq 0.02. \end{tabular}$



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8. Package outline



9. Packing information

Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package Description		Packing quantity		
			3000	10000	
PMSTA55	SOT323	4 mm pitch, 8 mm tape and reel	-115	-135	
PMSTA56					

[1] For further information and the availability of packing methods, see <u>Section 12</u>.

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10. Revision history

Table 9. Revision h	istory					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
PMSTA55_56_5	20100201	Product data sheet	-	PMSTA55_56_N_4		
Modifications:		of this data sheet has been of NXP Semiconductors.	redesigned to comply v	vith the new identity		
	 Legal texts 	have been adapted to the n	new company name whe	ere appropriate.		
	Section 1 "I	Product profile": amended				
	<u>Table 2 "Pinning"</u> : amended					
	 <u>Section 3 "Ordering information"</u>: added 					
	 <u>Section 4 "Marking"</u>: amended 					
	 Figure 1: superseded by minimized package outline drawing 					
	 Section 9 "Packing information": added 					
	 <u>Section 11 "Legal information"</u>: updated 					
PMSTA55_56_N_4	20080117	Product data sheet	-	PMSTA55_56_3		
PMSTA55_56_3	19990422	Product specification	-	PMSTA55_56_2		
PMSTA55_56_2	19980721	Product specification	-	PMSTA55_56_1		
PMSTA55_56_1	19970602	Product specification	-	-		

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11. Legal information

11.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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PMSTA55 56 5

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12. Contact information

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For sales office addresses, please send an email to: salesaddresses@nxp.com

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